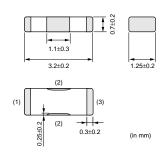
Data Sheet

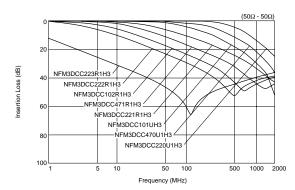
Chip EMIFIL® Capacitor Type

NFM3DC Series (1206 Size)

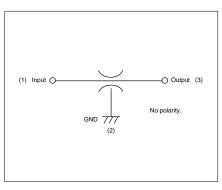
■ Dimension



■ IL of Main Item



■ Equivalent Circuit



■ Packaging

Code	Packaging	Minimum Quantity
L	180mm Plastic Tape	4000
В	Bulk(Bag)	500

■ Rated Value (□: packaging code)

Part Number	Capacitance	Rated Current	Rated Voltage	Insulation Resistance (min.)	Operating Temperature Range	Number of Circuit
NFM3DCC220U1H3□	22pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C	1
NFM3DCC470U1H3□	47pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C	1
NFM3DCC101U1H3	100pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C	1
NFM3DCC221R1H3□	220pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C	1
NFM3DCC471R1H3□	470pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C	1
NFM3DCC102R1H3□	1000pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C	1
NFM3DCC222R1H3□	2200pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C	1
NFM3DCC223R1H3□	22000pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C	1

■ ①Caution/Notice

⚠Caution (Rating)

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

• This data sheet is applied for CHIP EMIFIL® used for General Electronics equipment for your design.

				MIFIL® Capacitor Type > Chip EMIF	
		Data Shee	Į.		2
⚠ No					
⟨For	ort Control customers outside Japan	in the development production at-	okniling or utilization of any accurate	tional woonans or mass destructive	
wea	ata products should not be used or sold for use cons (nuclear weapons, chemical or biological customers in Japan	weapons, or missiles), or any other v	veapons.	iionai weapons oi mass-uestructive	
For	products which are controlled items subject to t	the "Foreign Exchange and Foreign 1	Frade Law" of Japan, the export lice	ense specified by the law is required	

- 2. Please contact our sales representatives or product engineers before using the products in this data sheet for the applications listed below, which require especially high reliability for the prevention of defects which might directly damage to a third party's life, body or property, or when one of our products is intended for use in applications other than those specified in this data sheet.
 - 1 Aircraft equipment
- ② Aerospace equipment
- 3 Undersea equipment 5 Medical equipment
- (4) Power plant equipment
- 7) Traffic signal equipment
- 6 Transportation equipment (vehicles, trains, ships, etc.) Disaster prevention / crime prevention equipment
- Data-processing equipment
- Application of similar complexity and/or reliability requirements to the applications listed in the above
- 3. They are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering. If there are any questions, please contact our sales representatives or product engineers.
- 4. This data sheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering. Especially, please read rating and ACAUTION (for storage, operating, rating, soldering, mounting and handling) in them to prevent smoking and/or burning, etc.
- 5. You are able to read a detailed specification in the website of Search Engine (http://search.murata.co.jp/) or catalog library (http://www.murata.com/catalog/) before to require our product specification or to transact the approval sheet for product specification.
- 6. Please note that unless otherwise specified, we shall assume no responsibility whatsoever for any conflict or dispute that may occur in connection with the effect of our and/or a third party's intellectual property rights and other related rights in consideration of your use of our products and/or information described or contained in our data sheets. In this connection, no representation shall be made to the effect that any third parties are authorized to use the right mentioned above under licenses without our consent.
- 7. No ozone depleting substances (ODS) under the Montreal Protocol are used in our manufacturing process.
 - This data sheet is applied for CHIP EMIFIL[®] used for General Electronics equipment for your design.